

1.8 V/2.5 V/3.3 V 8 GHz/14 Gbps Differential 1:4 Clock/Data CML Fanout Buffer w/ Selectable Input Equalizer

Multi-Level Inputs w/ Internal Termination

NB7VQ14M

Description

The NB7VQ14M is a high performance differential 1:4 CML fanout buffer with a selectable Equalizer receiver. When placed in series with a Clock/Data path operating up to 8 GHz or 14 Gb/s, respectively, the NB7VQ14M inputs will compensate the degraded signal transmitted across a FR4 PCB backplane or cable interconnect and output four identical CML copies of the input signal with a 1.8 V, 2.5 V or 3.3 V power supply. Therefore, the serial data rate is increased by reducing Inter-Symbol Interference (ISI) caused by losses in copper interconnect or long cables. The Equalizer ENable pin (EQEN) allows the IN/IN inputs to either flow through or bypass the Equalizer section. Control of the Equalizer function is realized by setting EQEN; When EQEN is set Low, the IN/IN inputs bypass the Equalizer. When EQEN is set High, the IN/IN inputs flow through the Equalizer. The default state at start-up is LOW. As such, NB7VQ14M is ideal for SONET, GigE, Fiber Channel, Backplane and other Clock/Data distribution applications.

The differential inputs incorporate internal 50 Ω termination resistors that are accessed through the VT pin. This feature allows the NB7VQ14M to accept various logic level standards, such as LVPECL, CML or LVDS. The 1:4 fanout design was optimized for low output skew applications.

The NB7VQ14M is a member of the GigaComm™ family of high performance clock products.

Features

- Input Data Rate > 14 Gb/s, Typical
- Input Clock Frequency > 8 GHz, Typical
- 165 ps Typical Propagation Delay
- 30 ps Typical Rise and Fall Times
- < 15 ps Maximum Output Skew
- < 0.8 ps Maximum RMS Clock Jitter
- < 10 ps pp of Data Dependent Jitter
- Differential CML Outputs, 400 mV Peak-to-Peak, Typical
- Selectable Input Equalization
- Operating Range: $V_{CC} = 1.71 \text{ V}$ to 3.6 V with GND = 0 V
- Internal Input Termination Resistors, 50 Ω
- -40°C to +85°C Ambient Operating Temperature
- These are Pb-Free Devices

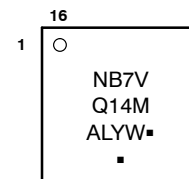


ON Semiconductor®

www.onsemi.com

MARKING DIAGRAM*


1
QFN-16
MN SUFFIX
CASE 485G

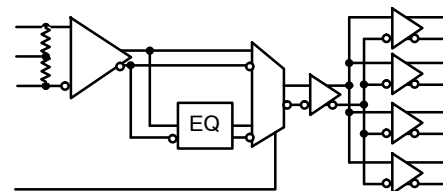


A	= Assembly Location
L	= Wafer Lot
Y	= Year
W	= Work Week
▪	= Pb-Free Package

(Note: Microdot may be in either location)

*For additional marking information, refer to Application Note [AND8002/D](#).

SIMPLIFIED BLOCK DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

NB7VQ14M

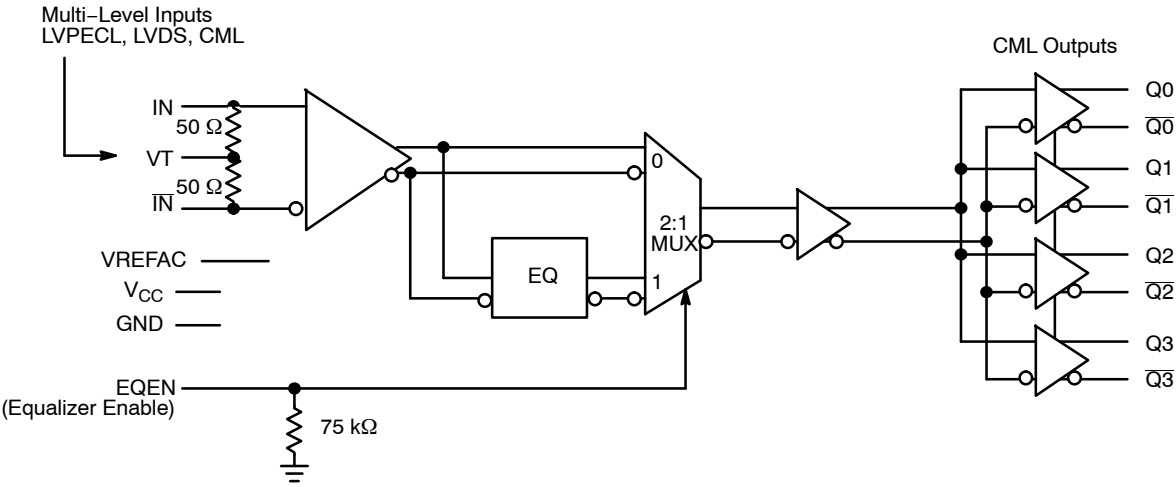


Figure 1. Detailed Block Diagram of NB7VQ14M

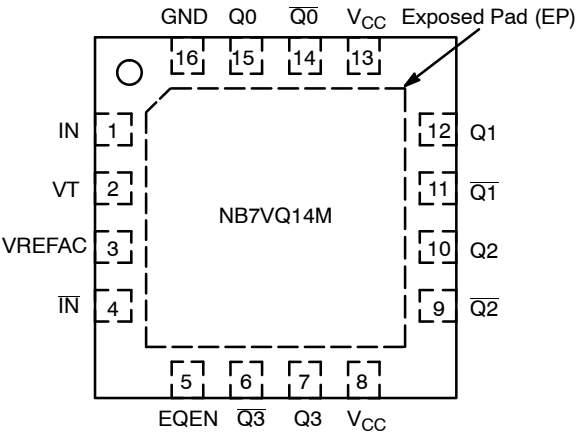


Table 1. EQUALIZER ENABLE FUNCTION

EQEN	Function
0	IN / IN Inputs By-pass the Equalizer section
1	Inputs flow through the Equalizer

Figure 2. QFN-16 Pinout (Top View)

NB7VQ14M

Table 2. PIN DESCRIPTION

Pin	Name	I/O	Description
1	IN	LVPECL, CML, LVDS Input	Non-inverted Differential Input. (Note 1)
2	VT		Internal 100 Ω Center-tapped Termination Pin for IN / $\overline{\text{IN}}$
3	VREFAC		Output Voltage Reference for Capacitor-Coupled Inputs, only
4	$\overline{\text{IN}}$	LVPECL, CML, LVDS Input	Inverted Differential Input. (Note 1)
5	EQEN	LVCMOS Input	Equalizer Enable Input; pin will default LOW when left open (has internal pull-down resistor)
6	$\overline{\text{Q3}}$	CML Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to V_{CC} .
7	Q3	CML Output	Non-inverted Differential Output. Typically Terminated with 50 Ω Resistor to V_{CC} .
8	VCC	–	Positive Supply Voltage
9	$\overline{\text{Q2}}$	CML Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to V_{CC} .
10	Q2	CML Output	Non-inverted Differential Output. Typically Terminated with 50 Ω Resistor to V_{CC} .
11	$\overline{\text{Q1}}$	CML Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to V_{CC} .
12	Q1	CML Output	Non-inverted Differential Output. Typically Terminated with 50 Ω Resistor to V_{CC} .
13	VCC	–	Positive Supply Voltage
14	$\overline{\text{Q0}}$	CML Output	Inverted Differential Output. Typically Terminated with 50 Ω Resistor to V_{CC} .
15	Q0	CML Output	Non-inverted Differential Output. Typically Terminated with 50 Ω Resistor to V_{CC} .
16	GND	–	Negative Supply Voltage
–	EP	–	The Exposed Pad (EP) on the QFN–16 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is electrically connected to the die, and must be electrically and thermally connected to GND on the PC board.

1. In the differential configuration when the input termination pin (VT) is connected to a common termination voltage or left open, and if no signal is applied on IN / $\overline{\text{IN}}$ input, then, the device will be susceptible to self-oscillation.
2. All VCC and GND pins must be externally connected to a power supply for proper operation.

Table 3. ATTRIBUTES

Characteristics	Value
ESD Protection Human Body Model Machine Model	> 2 kV > 200 V
R _{PD} – EQEN Input Pulldown Resistor	75 kΩ
Moisture Sensitivity (Note 3) 16-QFN	Level 1
Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in
Transistor Count	210
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	

3. For additional information, see Application Note [AND8003/D](#).

Table 4. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Positive Power Supply – Core	GND = 0 V		4.0	V
V _{IO}	Positive Input/Output Voltage	GND = 0 V		–0.5 to V _{CC} + 0.5	V
V _{INPP}	Differential Input Voltage I _N – I _N			1.89	V
I _{IN}	Input Current Through R _T (50 Ω Resistor)			±40	mA
I _{OUT}	Output Current Through R _T (50 Ω Resistor)			±40	mA
I _{VREFAC}	VREFAC Sink/Source Current			±1.5	mA
T _A	Operating Temperature Range	16 QFN		–40 to +85	°C
T _{stg}	Storage Temperature Range			–65 to +150	°C
θ _{JA}	Thermal Resistance (Junction-to-Ambient) (Note 4)	0 lfpm 500 lfpm	16 QFN 16 QFN	42 35	°C/W °C/W
θ _{JC}	Thermal Resistance (Junction-to-Case) (Note 4)		16 QFN	4	°C/W
T _{sol}	Wave Solder Pb-Free			265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

4. JEDEC standard multilayer board – 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

NB7VQ14M

Table 5. DC CHARACTERISTICS, MULTI-LEVEL INPUTS $V_{CC} = 1.71 \text{ V to } 3.6 \text{ V}$, $GND = 0 \text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ (Note 5)

Symbol	Characteristic	Min	Typ	Max	Unit	
POWER SUPPLY CURRENT						
V _{CC}	Power Supply Voltage	V _{CC} = 3.3 V	3.135	3.3	3.6	V
		V _{CC} = 2.5 V	2.375	2.5	2.625	
		V _{CC} = 1.8 V	1.71	1.8	1.89	
I _{CC}	Power Supply Current (Inputs and Outputs Open)		170	210	mA	

CML OUTPUTS (Note 6)

V_{OH}	Output HIGH Voltage	$V_{CC} = 3.3 \text{ V}$ $V_{CC} = 2.5 \text{ V}$ $V_{CC} = 1.8 \text{ V}$	$V_{CC} - 30$ 3270 2470 1770	$V_{CC} - 5$ 3295 2495 1795	V_{CC} 3300 2500 1800	mV
V_{OL}	Output LOW Voltage	$V_{CC} = 3.3 \text{ V}$ $V_{CC} = 2.5 \text{ V}$ $V_{CC} = 1.8 \text{ V}$	$V_{CC} - 525$ 2775 1975 1275	$V_{CC} - 425$ 2875 2075 1375	$V_{CC} - 325$ 2975 2175 1475	mV

DIFFERENTIAL INPUT DRIVEN SINGLE-ENDED (see Figures 5 and 7) (Note 7)

V_{IH}	Single-ended Input HIGH Voltage	$V_{th} + 100$		V_{CC}	mV
V_{IL}	Single-ended Input LOW Voltage	GND		$V_{th} - 100$	mV
V_{th}	Input Threshold Reference Voltage Range (Note 8)	1050		$V_{CC} - 100$	mV
V_{ISE}	Single-ended Input Voltage Amplitude ($V_{IH} - V_{IL}$)	200		2800	mV

VREFAC

V_{REFAC}	Output Reference Voltage @ 100 μA for capacitor – coupled inputs, only (Note 9)	$V_{CC} = 3.3 \text{ V}$ $V_{CC} = 2.5 \text{ V}$ $V_{CC} = 1.8 \text{ V}$	$V_{CC} - 650$ 2650 1850 1150	$V_{CC} - 500$ 2800 2000 1300	$V_{CC} - 350$ 2950 2150 1450	mV
-------------	--	--	--	--	--	----

DIFFERENTIAL INPUTS DRIVEN DIFFERENTIALLY (see Figures 6 and 8) (Note 9)

V_{IHD}	Differential Input HIGH Voltage	1200		V_{CC}	mV
V_{ILD}	Differential Input LOW Voltage	0		$V_{IHD} - 100$	mV
V_{ID}	Differential Input Voltage ($V_{IHD} - V_{ILD}$)	100		1200	mV
V_{CMR}	Input Common Mode Range (Differential Configuration) (Note 10) (Figure 9)	1050		$V_{CC} - 50$	mV
I_{IH}	Input HIGH Current $I_N / \bar{I}_N$, (VT Open)	-150		150	μA
I_{IL}	Input LOW Current $I_N / \bar{I}_N$, (VT Open)	-150		150	μA

CONTROL INPUTS (EQEN)

V_{IH}	Input HIGH Voltage for Control Pins	$V_{CC} \times 0.65$		V_{CC}	V
V_{IL}	Input LOW Voltage for Control Pins	GND		$V_{CC} \times 0.35$	V
I_{IH}	Input HIGH Current	-150		150	μA
I_{IL}	Input LOW Current	-150		150	μA

TERMINATION RESISTORS

R_{TIN}	Internal Input Termination Resistor	45	50	55	Ω
R_{TOUT}	Internal Output Termination Resistor	45	50	55	Ω

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm.

- Input and output parameters vary 1:1 with V_{CC} .
- CML outputs loaded with 50 Ω to V_{CC} for proper operation.
- V_{th} , V_{IH} , V_{IL} , and V_{ISE} parameters must be complied with simultaneously.
- V_{th} is applied to the complementary input when operating in single-ended mode.
- V_{IHD} , V_{ILD} , V_{ID} , and V_{CMR} parameters must be complied with simultaneously.
- V_{CMR} min varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC} . The V_{CMR} range is referenced to the crosspoint side of the differential input signal.

NB7VQ14M

Table 6. AC CHARACTERISTICS $V_{CC} = 1.71 \text{ V to } 3.6 \text{ V}$, $GND = 0 \text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ (Note 11)

Symbol	Characteristic	Min	Typ	Max	Unit
f_{MAX}	Maximum Input Clock Frequency; $V_{OUT} \geq 200 \text{ mV}$	7	8.5		GHz
$f_{DATAMAX}$	Maximum Operating Data Rate NRZ, (PRBS23)	10	14		Gbps
V_{OUTPP}	Output Voltage Amplitude, EQEN = 0 or 1 (Note 15) $f_{in} \leq 7 \text{ GHz}$ (See Figure 10)	200	400		mV
t_{PLH} , t_{PHL}	Propagation Delay IN to Q_x	125	175	225	ps
t_{SKEW}	Duty Cycle Skew (Note 12) Output – Output Within Device Skew Device to Device Skew		3	15 15 50	ps
t_{DC}	Output Clock Duty Cycle (Reference Duty Cycle = 50%) $f_{in} \leq 7 \text{ GHz}$	40	50	60	%
Φ_N	Phase Noise, $f_{in} = 1 \text{ GHz}$ 10 kHz 100 kHz 1 MHz 10 MHz 20 MHz 40 MHz		-134 -136 -150 -151 -151 -151		dBc
$t_{j\Phi N}$	Integrated Phase Jitter $f_{in} = 1 \text{ GHz}$, 12 kHz – 20 MHz Offset (RMS)		35		fs
t_{JITTER}	RMS Random Clock Jitter (Note 13) $f_{in} \leq 7 \text{ GHz}$ Peak-to-Peak Data Dependent Jitter (Note 14) $f_{IN} \leq 14 \text{ Gbps EQEN} = 0 (\leq 3'' \text{ FR4})$ $f_{IN} \leq 10 \text{ Gbps EQEN} = 1 (12'' \text{ FR4})$		0.2	0.8 10 10	ps rms ps pk-pk ps pk-pk
V_{INPP}	Input Voltage Swing/Sensitivity (Differential Configuration) (Note 15)	100		1200	mV
t_r t_f	Output Rise/Fall Times @ 1.0 GHz (20% – 80%) $Q_x, \overline{Q}_x$	15	30	45	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm.

11. Measured by forcing V_{INPP} 400mV from a 50% duty cycle clock source. All loading with an external $R_L = 50 \Omega$ to V_{CC} . Input edge rates 40 ps (20% – 80%).

12. Skew is measured between outputs under identical transitions and conditions @ 0.5 GHz. Duty cycle skew is measured between differential outputs using the deviations of the sum of T_{pw-} and T_{pw+} @ 0.5 GHz.

13. Additive RMS jitter with 50% duty cycle clock signal.

14. Additive peak-to-peak data dependent jitter with input NRZ data at PRBS23.

15. Input and output voltage swings are single-ended measurements operating in a differential mode.

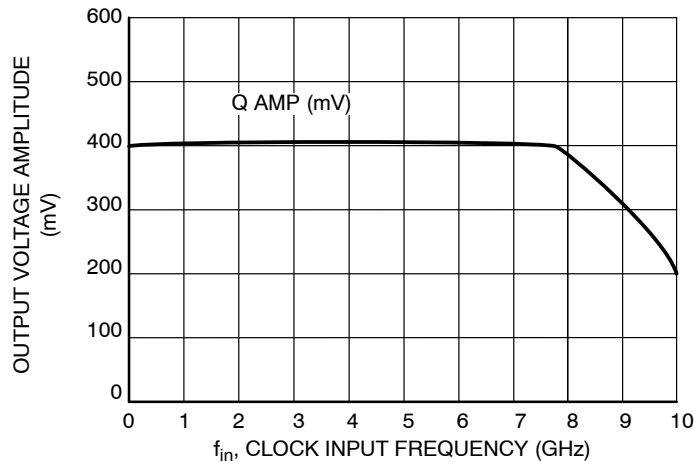


Figure 3. CLOCK Output Voltage Amplitude (V_{OUTPP}) vs. Input Frequency (f_{in}) at Ambient Temperature (Typical)

NB7VQ14M

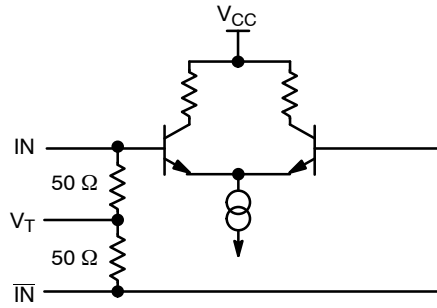


Figure 4. Input Structure

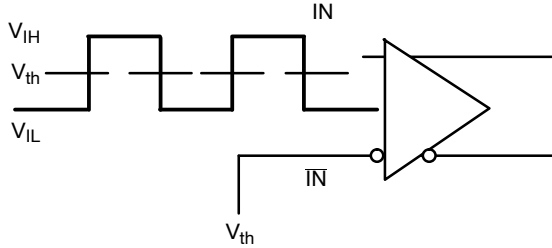


Figure 5. Differential Input Driven Single-Ended

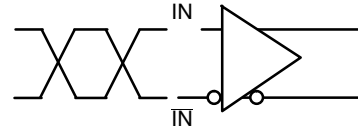


Figure 6. Differential Inputs Driven Differentially

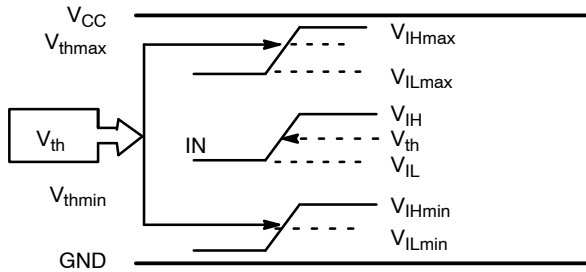


Figure 7. V_{th} Diagram

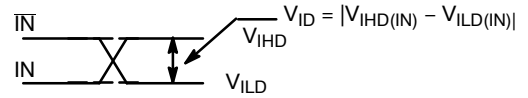


Figure 8. Differential Inputs Driven Differentially

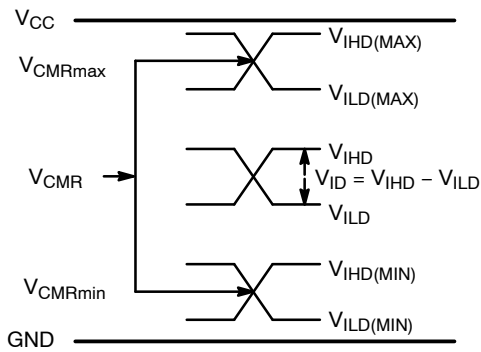


Figure 9. V_{CMR} Diagram

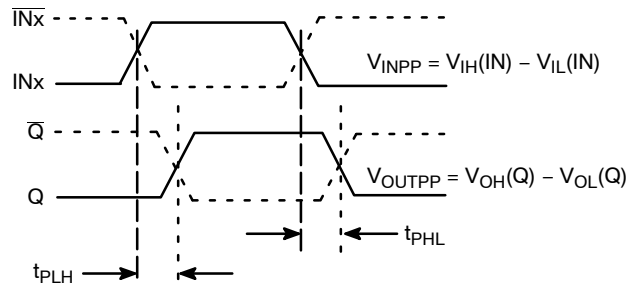


Figure 10. AC Reference Measurement

The diagram illustrates a differential signal path. On the left, an LVPECL Driver is connected to a differential pair of transmission lines, each with a characteristic impedance $Z_O = 50 \Omega$. The driver's output is connected to the IN pins of an NB7VQ14M device. The NB7VQ14M device has a differential input structure with two 50Ω resistors connected to a common mode voltage $V_T = V_{CC} - 2V$. The driver's output is also connected to GND/ V_{EE} , and the NB7VQ14M device is connected to GND.

The diagram shows an LVDS Driver connected to an NB7VQ14M receiver. The driver's output lines have a characteristic impedance $Z_O = 50 \Omega$. The receiver's input lines also have $Z_O = 50 \Omega$. The receiver's input pins are labeled IN and $\overline{\text{IN}}$. A pull-up network is connected to the IN pin, consisting of two 50Ω resistors in series, connected to V_{CC} . The $\overline{\text{IN}}$ pin is connected to $V_T = \text{Open}$. Both the driver and receiver are connected to V_{CC} and GND.

The diagram shows a Differential Driver connected to the IN and IN inputs of an NB7VQ14M device. The driver's output lines are labeled $Z_O = 50 \Omega$. The driver is powered by V_{CC} and GND. The NB7VQ14M is also powered by V_{CC} and GND. The input pins of the device are connected to the driver outputs through 50Ω resistors. The threshold voltage V_T is set to V_{REFAC}^* .

The diagram shows a differential driver circuit. On the left, a block labeled "Differential Driver" is connected to V_{CC} and GND. Its output is connected to a transmission line with characteristic impedance $Z_O = 50 \Omega$. The other end of the transmission line is connected to the "IN" pin of an "NB7VQ14M" device. The "IN" pin is also connected to a 50Ω resistor to V_{CC} and a 50Ω resistor to GND. A terminal labeled $VT = V_{REFAC} *$ is also connected to the "IN" pin. The "NB7VQ14M" device is also connected to V_{CC} and GND.

8

NB7VQ14M

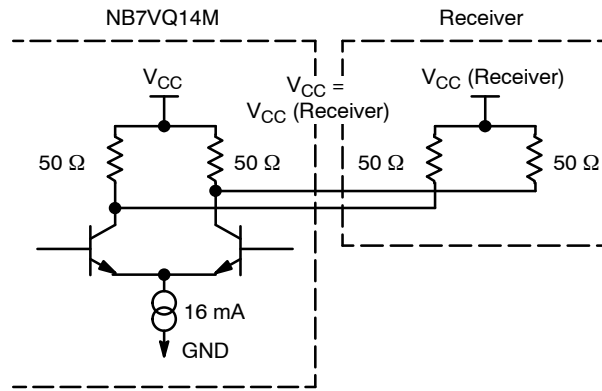


Figure 16. Typical CML Output Structure and Termination

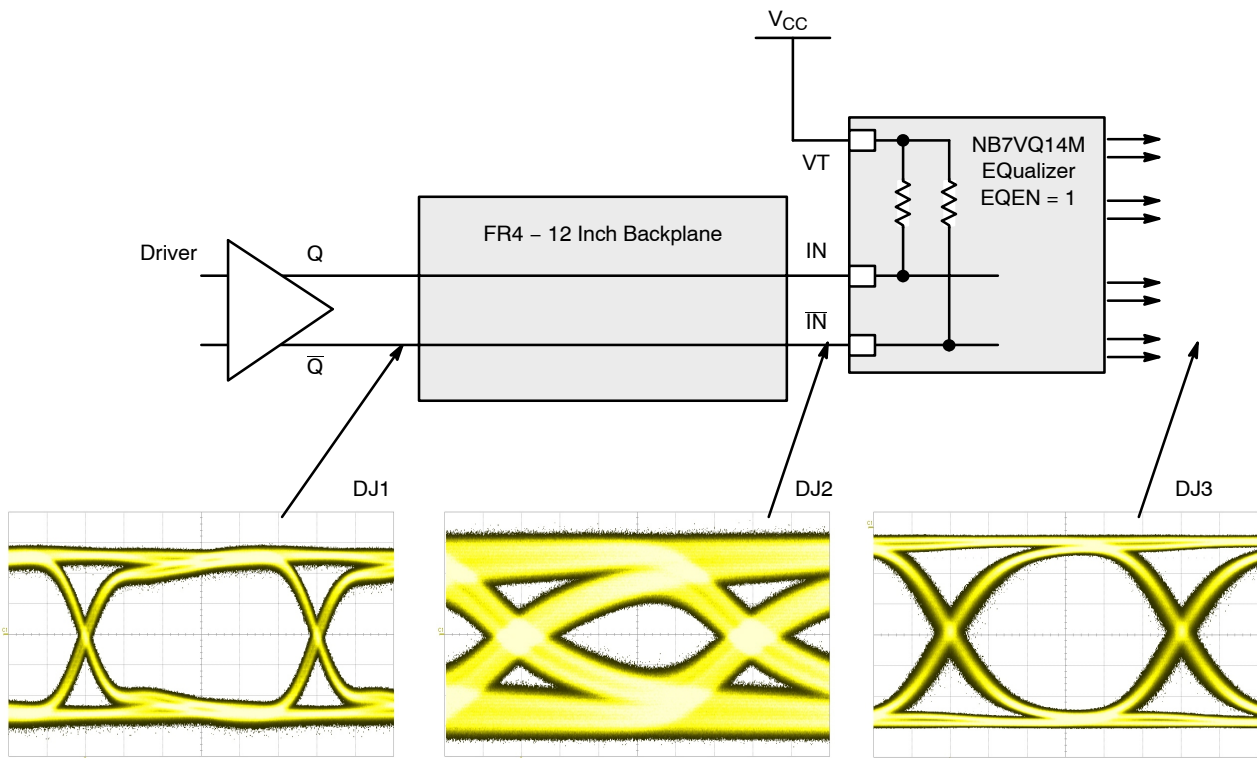


Figure 17. Typical NB7VQ14M Equalizer Application and Interconnect with PRBS23 pattern at 6.5 Gbps, EQEN = 1

ORDERING INFORMATION

Device	Package	Shipping [†]
NB7VQ14MMNG	QFN-16 (Pb-Free)	123 Units / Tube
NB7VQ14MMNHTBG	QFN-16 (Pb-Free)	100 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

GigaComm is a trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

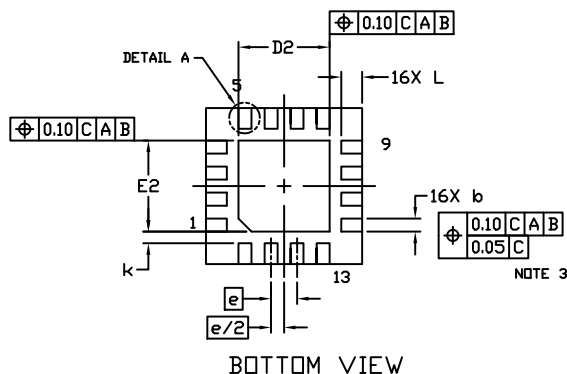
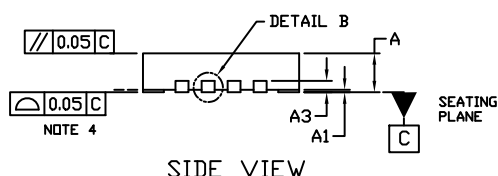
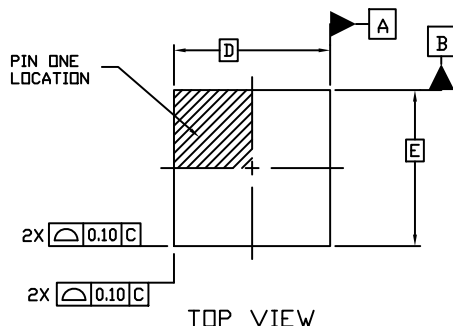
MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



SCALE 2:1

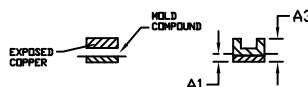
QFN16 3x3, 0.5P CASE 485G ISSUE G

DATE 08 OCT 2021

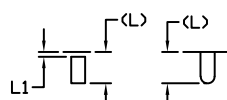


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.



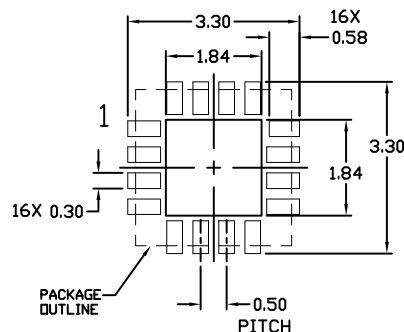
DETAIL B
ALTERNATE
CONSTRUCTIONS



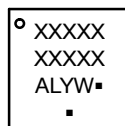
DETAIL A
ALTERNATE TERMINAL
CONSTRUCTIONS

DIM	MILLIMETERS		
	MIN.	NDM.	MAX.
A	0.80	0.90	1.00
A1	0.00	0.03	0.05
A3	0.20 REF		
b	0.18	0.24	0.30
D	3.00 BSC		
D2	1.65	1.75	1.85
E	3.00 BSC		
E2	1.65	1.75	1.85
e	0.50 BSC		
k	0.18 TYP		
L	0.30	0.40	0.50
L1	0.00	0.08	0.15

MOUNTING FOOTPRINT



GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON04795D	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	QFN16 3X3, 0.5P	PAGE 1 OF 1

onsemi and onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT

North American Technical Support:

Voice Mail: 1 800-282-9855 Toll Free USA/Canada

Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative